Shoulder 好达 SHOULDER ELECTRONICS CO., LTD.

CERAMIC RESONATOR Data Sheet

PRODUCT 产品: CERAMIC RESONATOR

MODEL NO 型号: ZTTCS....MX

PREPARED 编 制: Fengyu

CHECKED 审核: York

APPROVED 批 准:

DATE 日期: 2007-01-25

1. Scope

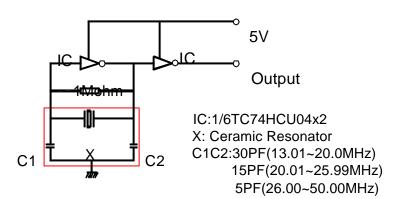
The specification is fit for ceramic resonator 13.01-50.00MHz.

2. Part NO: ZTTCS .. MX

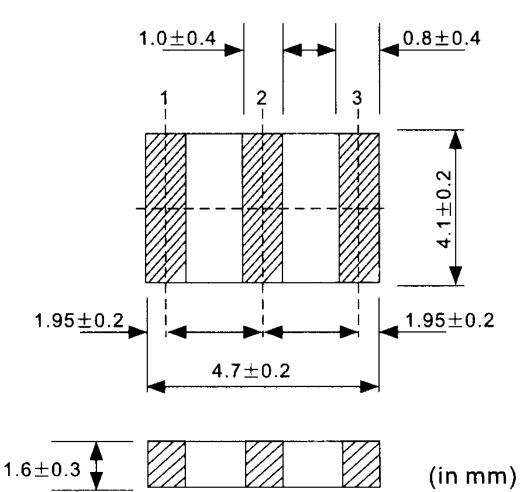
3. Electrical Characteristics

No.	Item	Characteristics				
3-1	Oscillate Frequency (MHz)	13.01-50.00				
3.2	Frequency Tolerance max	±0.5%				
3.3	Resonant Impedance max (Ω)	40				
3.4	Built – in Capacitance (PF)	Refer to test circuit				
3.5	Insulate Resistance min (M Ω)	100				
3.6	Withstanding Voltage D.C (V)	100 (max 5 sec)				
3.7	Voltage (1) D.C Voltage max (V) (2) Input Voltage max (V)	6 15Vp-p				
3.8	Temp characteristics of Oscillate frequency max	±0.3%				
3.9	Operating Temp Range (°C)	-20 ~ +80				
3.10	Storage Temp ("C)	-55 ~ +85				

4. Test Circuit



5. Dimension



6. Physical and Environmental Characteristics

No	ltem	Condition of Test	Performance Requirements			
6.1	Humidity	Keep the resonator at 40 ± 2 °C and 90-95% RH for 96 ± 4 hours. Then release the resonator into the room condition for 1 hour prior to the measurement.	It shall fulfill the specifications in Table 1.			
6.2	Vibration	Subject the resonator to vibration for 2 hours each in x,y and z axis with the amplitude of 1.5mm, the frequency shall be varied uniformly between the limits of 10-55Hz	It shall fulfill the specifications in Table 1.			
6.3	Mechanical Shock	Drop the resonator randomly onto a concrete floor from the height of 100 cm 3 times.	It shall fulfill the specifications in Table 1.			
6.4	Soldering Test	Passed through the re-flow oven under the following condition and left at room temperature for 1 hour before measurement.	It shall fulfill the specifications in Table 1.			

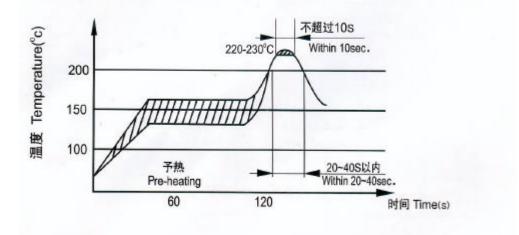
		Temperature at surface of the substrate	Time			
		Preheat 150±5℃	60±10 sec.			
		Peak 240±5℃	10±3 sec.			
6.5	Solder Ability	Dip the resonator solder bath at 230	More than 95% of the terminal surface shall be covered.			
6.6	High Temperature Exposure	Subject the resona \pm 4 hours. Then r into the room cond to the measuremen	It shall fulfill the specifications in Table 1.			
6.7	Low Temperature	± 4 hours. Then r	for to $-20\pm5^{\circ}$ for 96 release the resonator itions for 1 hour prior t.	It shall fulfill the specifications in Table 1.		
6.8	Temperature Cycling	minutes followed b of 85℃ for 30 m repeated 5 times w	ator to -20 °C for 30 y a high temperature hin. Cycling shall be with a transfer time of room condition for 1 easurement.	It shall fulfill the specifications in Table 1.		

TABLE1

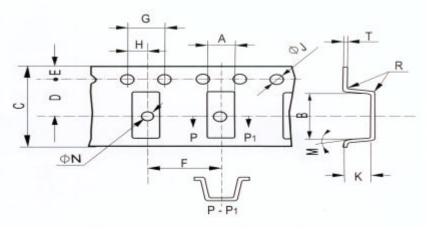
Item	Specification				
Oscillation Frequency Change	∆F/Fo≪0.3% max				
Resonant Impedance	∆Ro≪±10 Ohm				

7.

RECOMMENDED REFLOW SOLDERING STANDARD CONDITIONS



8. Packing



Tape Dimension (mm)

	A ±0.2	В ±0.2	C ±0.3	D ±0.1	Е ±0.1	F ±0.1	G ±0.1	H 土0.1	ØJ ±0.1	ØN ±0.1	M max	R max	К ±0.2	т ±0.1
MG	3.8	7.8	16.0	7.5									2.1	
MT	5.0	4.4	12.0	5.5	1.75	8.0	4.0	2.0	1.5	1.6	10"	0.3	1.8	0.3
MX	3.4	4.0	12.0	5.5									1.3	

Standard Package: 1Kpcs / reel